



DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
N-	2017	0.4Ω @ V _{GS} = 10V	0.8A
Channel	30V	0.7Ω @ V _{GS} = 4.5V	0.57A

Features and Benefits

- **Dual N-Channel MOSFET**
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Motor Control
- **Power Management Functions**
- DC-DC Converters

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.027 grams (Approximate)

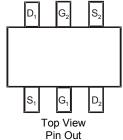


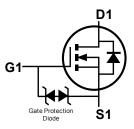


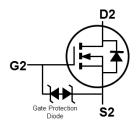
Top View

SOT363









Q1 N-Channel

Q2 N-Channel

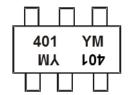
Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3401LDW-7	SOT363	3000/Tape & Reel
DMN3401LDW-13	SOT363	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



401 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} or \underline{Y} = Year (ex: \overline{I} = 2021) M = Month (ex: 9 = September)

Date Code Key

Date Code Rey												
Year	2018		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	F		I	J	K	L	M	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Notes:

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	30	V		
Gate-Source Voltage	V_{GSS}	±20	V		
Continuous Drain Current (Note 6) V _{GS} = 10V	I _D	0.8 0.6	Α		
Maximum Continuous Body Diode Forward Current	I _S	0.4	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	o)		I _{DM}	4	Α

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		P_{D}	0.29	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	433	°C/W
Total Power Dissipation (Note 6)		P_{D}	0.35	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	360	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

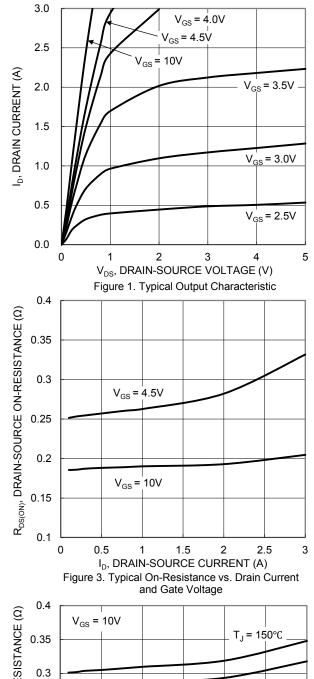
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1.0	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		_	±10	μΑ	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	$V_{GS(TH)}$	8.0	1.2	1.6	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	D	_	0.2	0.4	Ω	$V_{GS} = 10V, I_D = 0.59A$	
Static Dialii-Source Oil-Resistance	R _{DS(ON)}	_	0.3	0.7	12	$V_{GS} = 4.5V$, $I_D = 0.2A$	
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 10mA$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	50	_	pF	15)/)/	
Output Capacitance	Coss	_	12	_	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss		10		pF	1 - 1:001112	
Gate Resistance	R_g		58		Ω	$V_{DS} = V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	0.5		nC		
Total Gate Charge (V _{GS} = 10V)	Qg	_	1.2	_	nC	V _{DS} = 10V, V _{GS} = 10V	
Gate-Source Charge	Q_{gs}	_	0.2	_	nC	I _D = 250mA	
Gate-Drain Charge	Q_{gd}	_	0.1		nC		
Turn-On Delay Time	t _{D(ON)}	_	3.5	_	ns		
Turn-On Rise Time	t _R	_	3.3	_	ns	$V_{GS} = 10V, V_{DS} = 30V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	16.8	_	ns	$I_D = 100 \text{mA}, R_G = 25 \Omega$	
Turn-Off Fall Time	t_{F}		13.8	_	ns		

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.





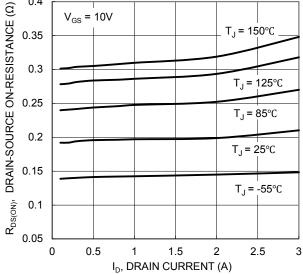
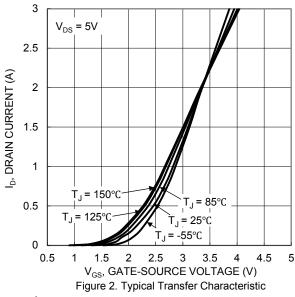
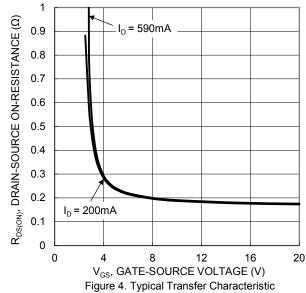


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





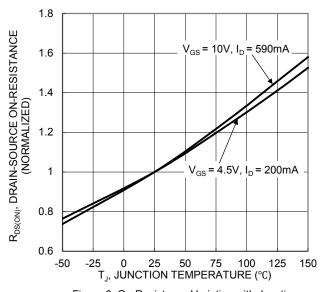


Figure 6. On-Resistance Variation with Junction Temperature





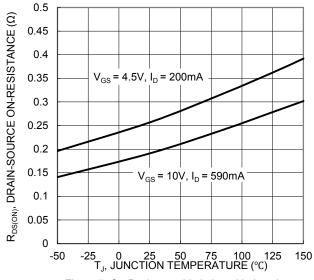
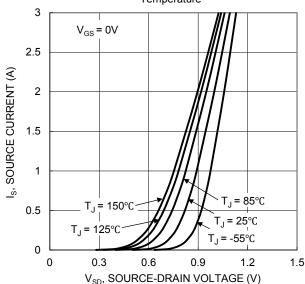


Figure 7. On-Resistance Variation with Junction Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

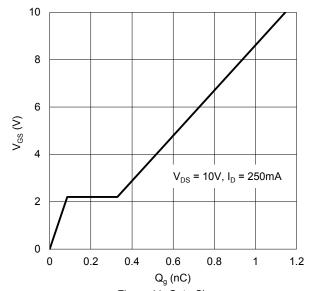


Figure 11. Gate Charge

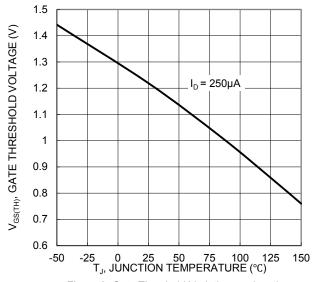
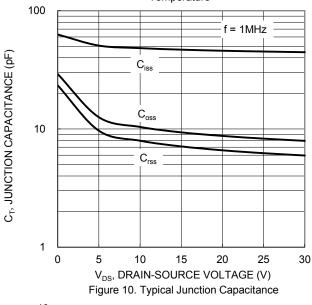
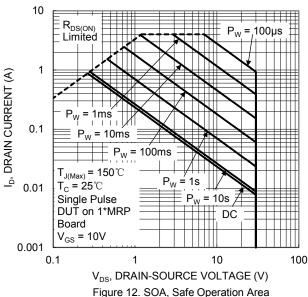


Figure 8. Gate Threshold Variation vs. Junction Temperature







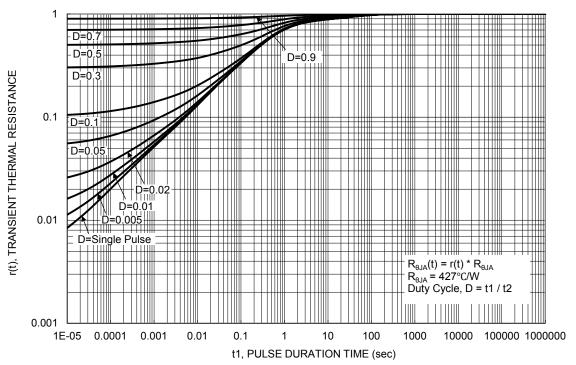


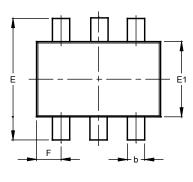
Figure 13. Transient Thermal Resistance

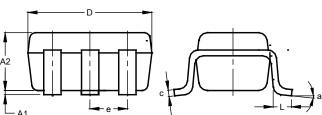


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



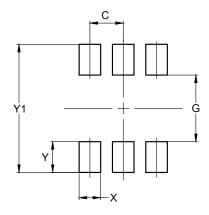


SOT363						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.10	0.30	0.25			
C	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	O	.650 E	SC			
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



Dimensions	Value		
Dillielisions	(in mm)		
С	0.650		
G	1.300		
Х	0.420		
Υ	0.600		
Y1	2.500		



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